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December 2014

FDZ193P P-Channel 1.7V PowerTrench[®] WL-CSP MOSFET -20V, -1A, 90mΩ

Features

- Max $r_{DS(on)}$ = 90m Ω at V_{GS} = -4.5V, I_D = -1A
- Max r_{DS(on)} = 130mΩ at V_{GS} = -2.5V, I_D = -1A
- Max $r_{DS(on)}$ = 300m Ω at V_{GS} = -1.7V, I_D = -1A
- Occupies only 1.5 mm² of PCB area Less than 50% of the area of 2 x 2 BGA
- Ultra-thin package: less than 0.65 mm height when mounted to PCB
- RoHS Compliant



General Description

Designed on Fairchild's advanced 1.7V PowerTrench[®] process with state of the art "low pitch" WLCSP packaging process, the FDZ193P minimizes both PCB space and $r_{DS(on)}$. This advanced WLCSP MOSFET embodies a breakthrough in packaging technology which enables the device to combine excellent thermal transfer characteristics, ultra-low profile packaging, low gate charge, and low $r_{DS(on)}$.

Application

- Battery management
- Load switch
- Battery protection



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DS}	Drain to Source Voltage		-20	V	
V _{GS}	Gate to Source Voltage		±12	V	
I _D	Drain Current -Continuous	(Note 1a)	-3		
	-Pulsed		-15	A	
P _D	Power Dissipation	(Note 1a)	1.9	14/	
	Power Dissipation	(Note 1b)	0.9	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	65	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	133	C/vv

Package Marking and Ordering Information

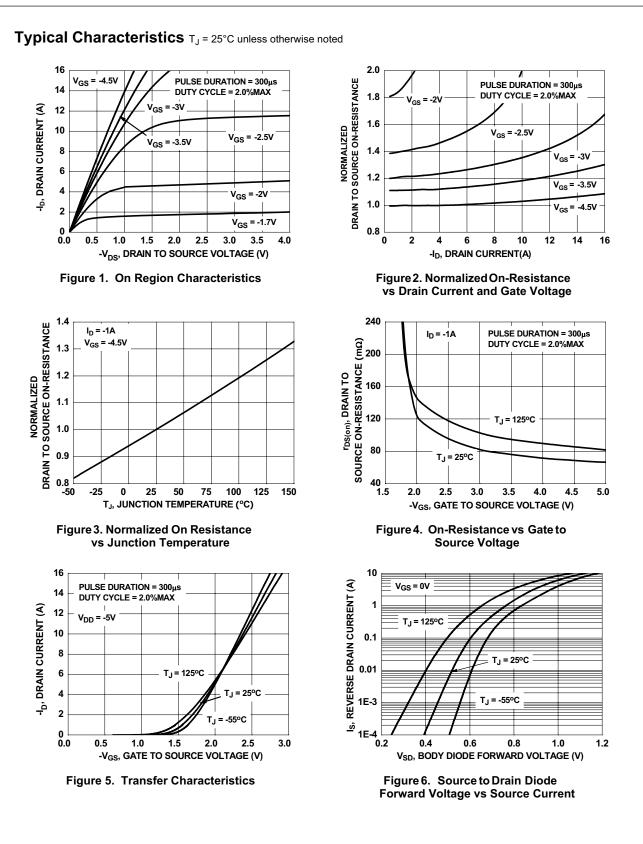
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
2	FDZ193P	WL-CSP	7"	8mm	5000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250μA, V _{GS} = 0V	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C		-11		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -16V, V _{GS} = 0V			-1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±12V, V_{GS} = 0V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250μA	-0.6	-0.9	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{cl}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C		3		mV/°C
5	· ·	V _{GS} = -4.5V, I _D = -1A		66	90	
_		$V_{GS} = -2.5V, I_D = -1A$		92	130	
r _{DS(on)}	Drain to Source On Resistance	$V_{GS} = -1.7V, I_D = -1A$		195	300	mΩ
		$V_{GS} = -4.5V, I_D = -1A T_J = 125^{\circ}C$		84	123	1
I _{D(on)}	On to State Drain Current	$V_{GS} = -4.5V, V_{DS} = -5V$	-10			A
9 _{FS}	Forward Transconductance	V _{DS} = -5V, I _D = -1A		5.6		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			660		pF
C _{oss}	Output Capacitance	V _{DS} = -10V, V _{GS} = 0V,		150		pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		90		pF
R _g	Gate Resistance	f = 1MHz		9.5		Ω
_	Characteristics					
t _{d(on)}	Turn-On Delay Time			13	23	ns
t _r	Rise Time	V _{DD} = -10V, I _D = -1A		10	20	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = -4.5V, R_{GEN} = 6 Ω		28	45	ns
•a(011) tr	Fall Time	-		21	34	ns
Q _{g(TOT)}	Total Gate Charge at 10V	$V_{GS} = 0V$ to $10V$ $V_{DD} = -10V$		7	10	nC
Q_{gs}	Gate to Source Gate Charge	$I_D = -1A$		1		nC
Q _{gd}	Gate to Drain "Miller" Charge			2		nC
	Irce Diode Characteristics		I		1	1
		Forward Current			-1.1	A
				-0.7	-1.2	V
	Reverse Recovery Time			19		ns
	Reverse Recovery Charge	—I _F = -1A, di/dt = 100A/μs		6		nC
I _S V _{SD} t _{rr} Q _{rr} Notes: 1: R _{0JA} is determ side of the sol	· ·	$V_{GS} = 0V$, $I_S = -1.1A$ (Note 2) $I_F = -1A$, di/dt = 100A/ μ s d on a 1.5 x 1.5 in. board of FR-4 material. The the ll reference point for the case is defined as the to esign.		19 6 ce from the ju the copper cl	unction to the hip carrier. R d on a	

FDZ193P Rev.C4 (W)

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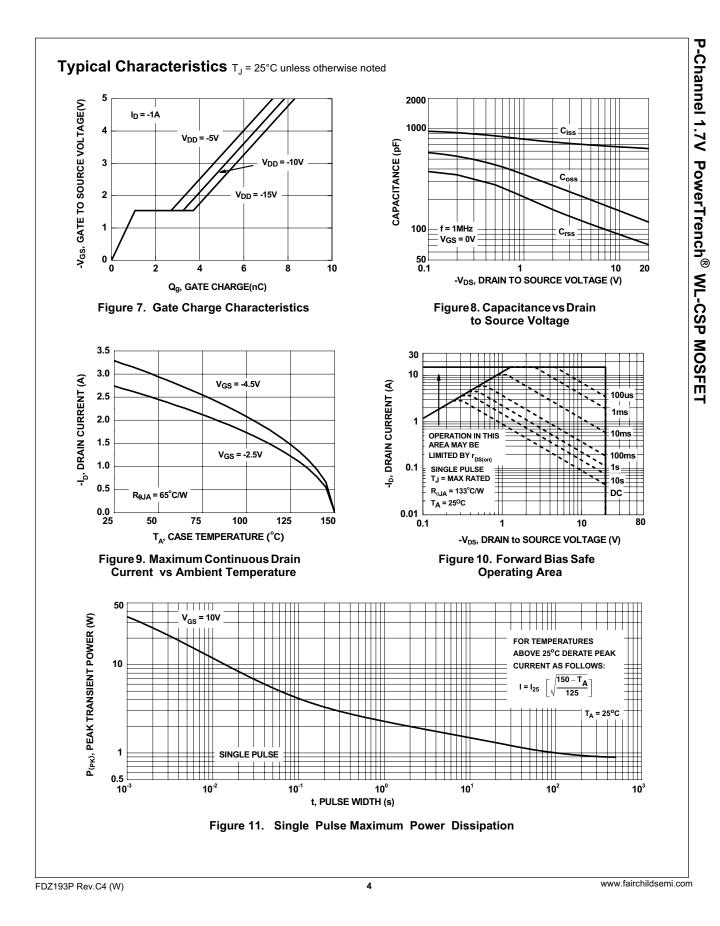
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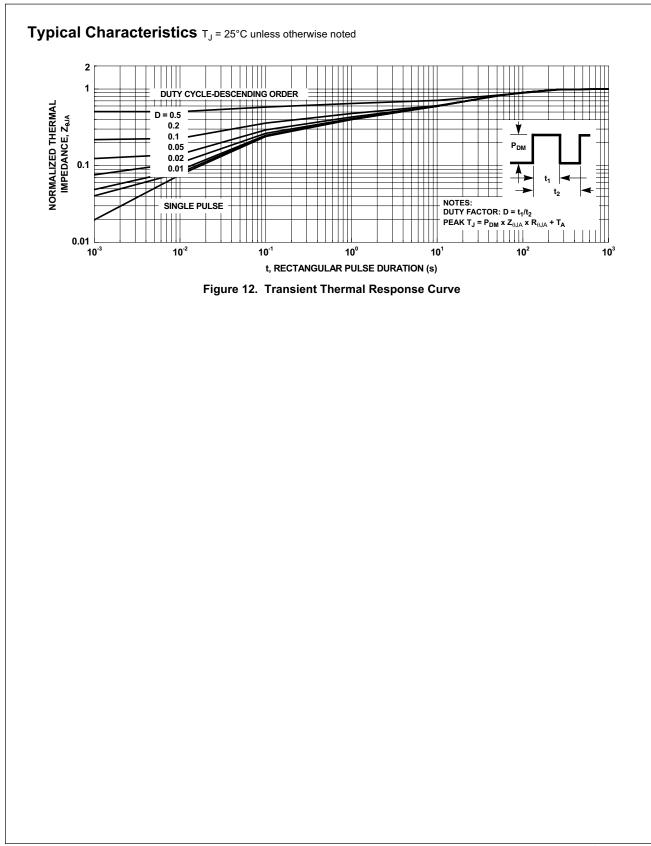


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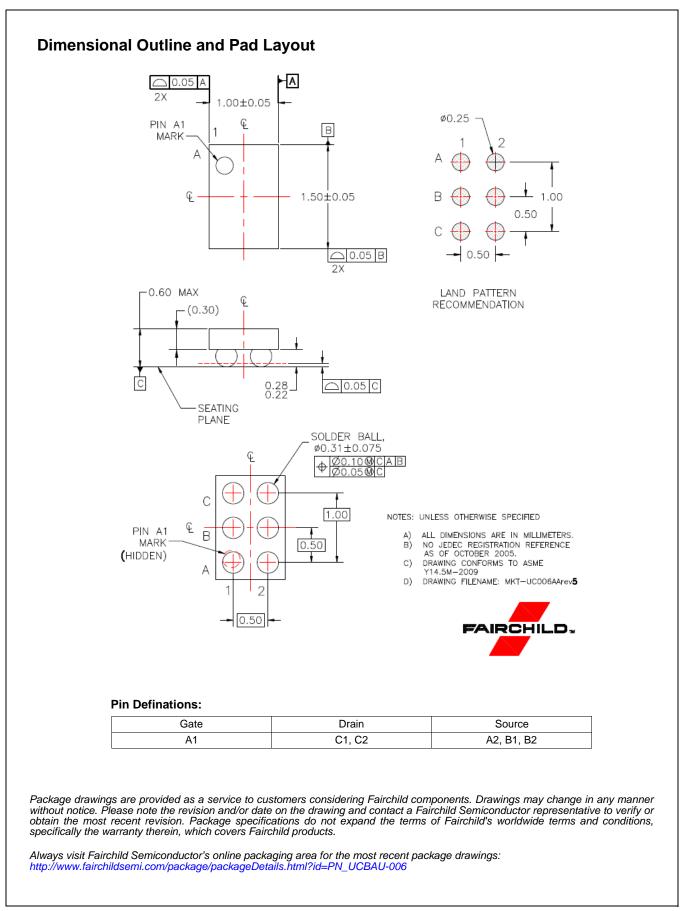




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